

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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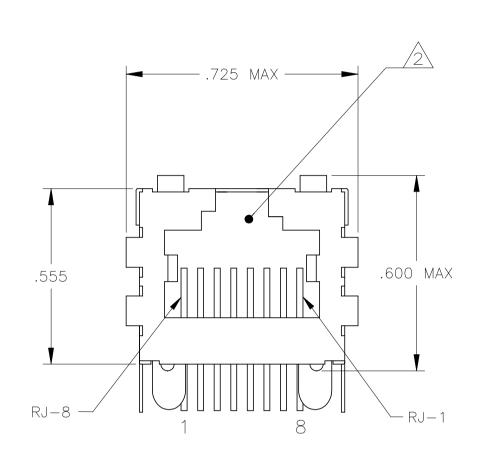
--.050 TYP

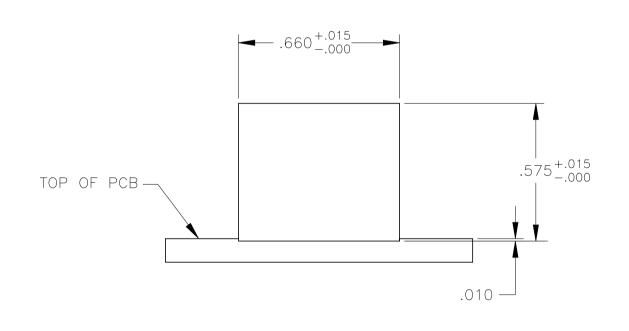
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Pin Designations

REVISIONS EC-1411035 COMPANY LOGO CHANGE 05JAN2015 HY KZ

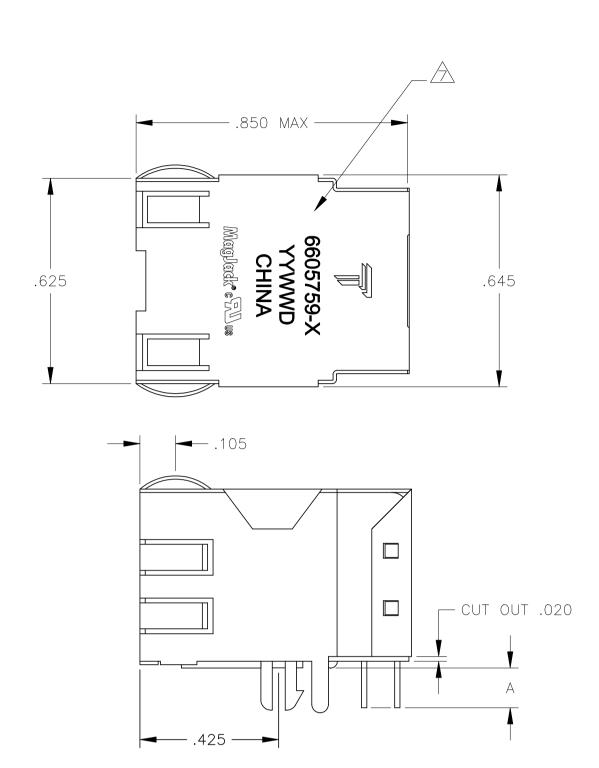
## **MECHANICAL:**

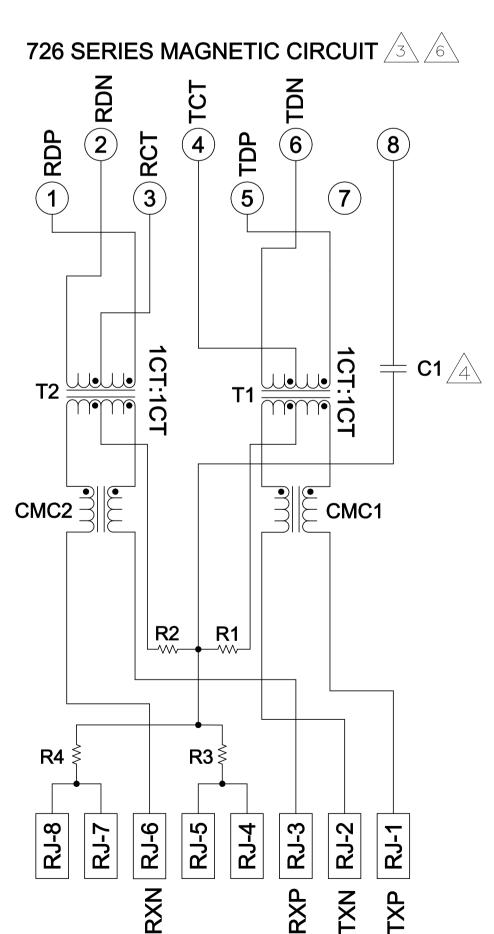




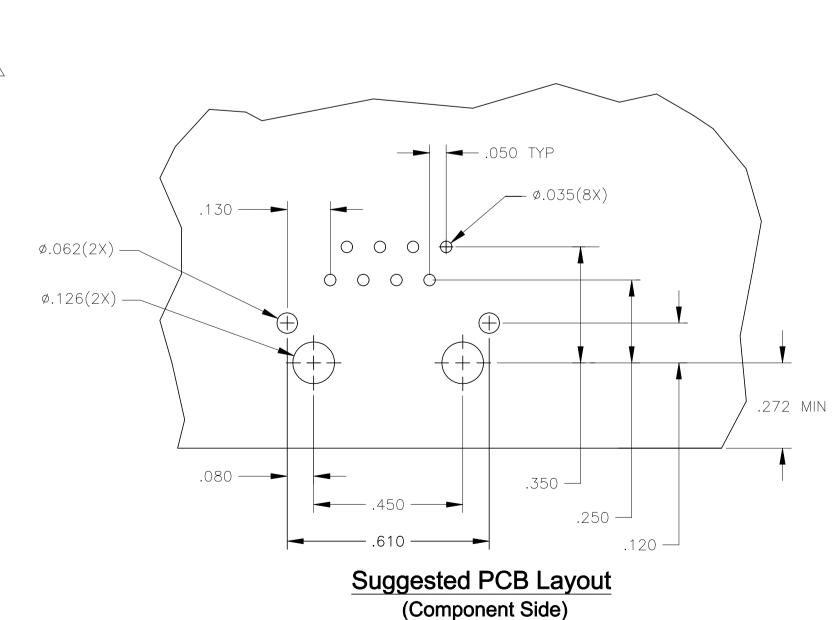
**Suggested Panel Cutout** 

TRP Connector





R1-R4 = 75 OHMS, 1/16W RESISTORS.



C1 = 1000 pF, 2kV DECOUPLING CAPACITOR

1 MATERIALS:

-HOUSING - THERMOPLASTIC PET POLYESTER FLAMMABILITY RATING UL 94V-0. -SHIELD - 0.010" THICK, C26800 BRASS PREPLATED WITH 30 $\mu$ INCH MIN SEMI-BRIGHT NICKEL, SOLDER TABS POST DIPPED WITH 100 $\mu$ INCH MIN SAC SOLDER. -MOD JACK CONTACTS - 0.0157" imes 0.018" PHOSPHOR BRONZE, 50 $m{\mu}$ INCH MIN OVERALL NICKEL UNDERPLATE, WITH SELECT 50 $\mu$ INCH MIN HARD GOLD FINISH PLATE. SOLDERTAILS WITH 100 $\mu$ INCH MIN MATTE TIN AND/OR SAC SOLDER DIP.

RJ45 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUB PART F.

3 MAGNETICS

-IMPEDANCE: 100 OHMS -TURNS RATIO (CHIP: CABLE): TX = 1:1, RX = 1:1 -OPEN CIRCUIT INDUCTANCE (OCL): 350 $\mu$ H MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM 0°C TO 70°C, TX AND RX -PERFORMANCE @ 25°C: INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz RETURN LOSS (RL): 18dB MIN FROM 0.5MHZ TO 30MHZ 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz 12dB MIN FROM 60.1MHz TO 80MHz CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz 33-20\*LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz -ISOLATION VOLTAGE: 2250 VDC (MAX) FOR 60 SECONDS WITH A RISE TIME OF 500 V/SEC.

4 IF NO CAPACITOR, TRACE IS CONTINUOUS.

108-2100

5. OPERATING TEMPERATURE: FROM 0° TO +70°C.

INDICATED CONNECTIONS ARE FOR NIC CONFIGURATION. THE MAGNETICS ARE SYMMETRIC TO SUPPORT AUTO-MDI/MDIX.

TRP CONNECTOR LOGO, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN.

8. THESE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PEAK WAVE SOLDERING TEMPERATURE IS 265°C MAX, 10 SECONDS MAX.

OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

> 1-6605759-1  $.090 \pm .010$ .145±.010 NO 6605759-2 .145±.010 YES 6605759-1 DECOUPLING CAPACITOR DIM A PART NUMBER THIS DRAWING IS A CONTROLLED DOCUMENT. DONGGUAN CHINA 1X1 726 10/100 TAB UP W/O LED ± -± .010 ± .005 ± -MAGJACK SINGLE

NON-POE

CUSTOMER DRAWING

RESTRICTED